



SSC65T50GT6

Trench FSII Fast IGBT

➤ Features

V_{CES}	V_{GES}	IC
650V	$\pm 20V$	80A@25°C
		50A@100°C

➤ Description

Using trench design and advanced FS (Field Stop) second generation technology, the 650V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation.

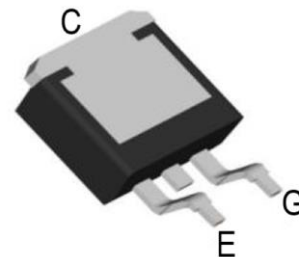
➤ Applications

- Welding Machines
- PFC Circuits
- UPS
- Power Inverters

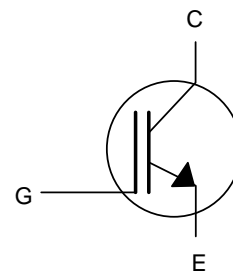
➤ Ordering Information

Device	Package	Shipping
SSC65T50GT6	TO-263-3L	50/Tube
Minimum Purchase Quantity: 1K/Box		

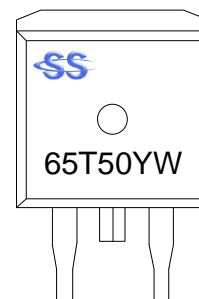
➤ Pin Configuration



TO-263-3L (Bottom View)



Pin Configuration



Marking

(YW: Internal Traceability Code)



➤ **Absolute Maximum Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter		Ratings	Unit
V_{CES}	Collector-Emitter Voltage		650	V
V_{GES}	Gate-Emitter Voltage		± 20	V
I_C	Collector Current	$T_C=25^{\circ}\text{C}$	80	A
		$T_C=100^{\circ}\text{C}$	50	
I_{Cpuls}	Pulsed Collector Current, t_p limited by T_{Jmax}		150	A
-	Turn off safe operating area, $V_{CE} = 1200\text{V}, T_J = 150^{\circ}\text{C}$		150	A
P_D	Power Dissipation ^a	$T_A=25^{\circ}\text{C}$	266	W
		$T_A=70^{\circ}\text{C}$	170	
T_J	Operating Junction and Storage Temperature Range		-55~150	$^{\circ}\text{C}$
T_{STG}	Operating Junction and Storage Temperature Range		-55~150	$^{\circ}\text{C}$
T_L	Maximum Temperature for Soldering		260	$^{\circ}\text{C}$

➤ **Thermal Resistance Ratings ($T_A=25^{\circ}\text{C}$ unless otherwise noted)**

Symbol	Parameter	Ratings	Unit
$R_{\theta JA}$	Junction-to-Ambient Thermal Resistance	50	$^{\circ}\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case Thermal Resistance	0.47	

Note:

- a. The maximum current rating is package limited.



➤ **Electrical Characteristics (T_A=25°C unless otherwise noted)**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 0.25mA	650			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V, V _{CE} =650V, T _J =25°C			1	uA
		V _{GE} =0V, V _{CE} =650V, T _J =150°C		5	100	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} = +20V, V _{CE} = 0V			100	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} = -20V, V _{CE} = 0V			-100	nA
V _{CE(sat)}	Collector-Emitter Saturation Voltage	I _C =50A, V _{GE} =15V, T _J =25°C		1.6		V
		I _C =50A, V _{GE} =15V, T _J =125°C		1.9		V
		I _C =50A, V _{GE} =15V, T _J =150°C		2.0		V
V _{GE(th)}	Gate Threshold Voltage	I _C = 1mA, V _{CE} = V _{GE}	3	4.5	6	V
G _{FS}	Transconductance	V _{CE} = 20V, I _C = 50A		26		S
C _{ies}	Input Capacitance	V _{CE} = 25V, V _{GE} = 0V, f = 1MHz, T _J = 25°C		1701		pF
C _{oes}	Output Capacitance			117		
C _{res}	Reverse Transfer Capacitance			101		
T _{D(ON)}	Turn-on delay time	T _J =25°C, V _{CC} =400V, I _C =50A, V _{GE} =0/15V, R _g =10Ω, Inductive Load		19		ns
T _r	Rise time			38		
T _{D(OFF)}	Turn-off delay time			249		
T _f	Fall time			56		
E _{on}	Turn-On Switching Loss			1.34		mJ
E _{off}	Turn-Off Switching Loss			1.49		
E _{ts}	Total Switching Loss			2.83		
T _{D(ON)}	Turn-on delay time	T _J =150°C, V _{CC} =400V, I _C =50A, V _{GE} =0/15V, R _g =10Ω, Inductive Load		18		ns
T _r	Rise time			43		
T _{D(OFF)}	Turn-off delay time			265		
T _f	Fall time			85		
E _{on}	Turn-On Switching Loss			1.53		mJ
E _{off}	Turn-Off Switching Loss			1.72		
E _{ts}	Total Switching Loss			3.25		
Q _G	Total Gate Charge	V _{CC} = 300V, I _C = 50A, V _{GE} = 0/15V		158		nC
Q _{GE}	Gate to Emitter Charge			13		
Q _{GC}	Gate to Collector Charge			32		



➤ Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise noted)

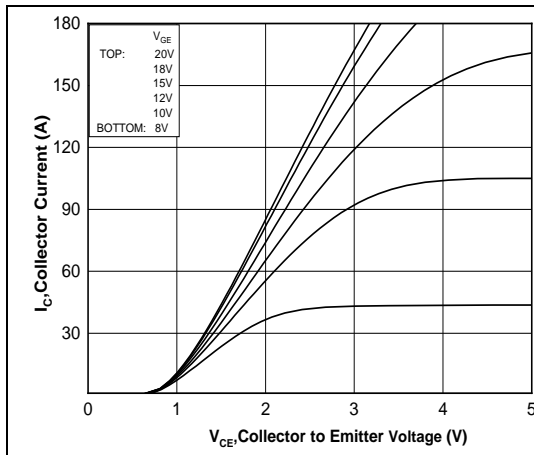


Figure 1. Output Characteristics($T_J=25^\circ\text{C}$)

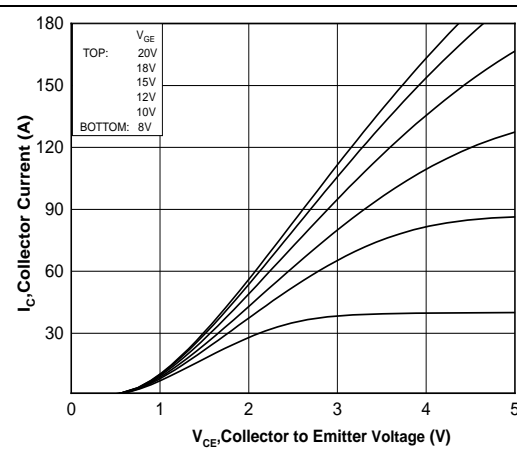


Figure 2. Output Characteristics($T_J=150^\circ\text{C}$)

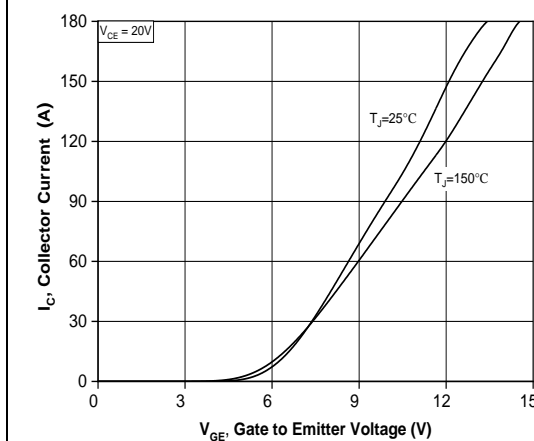


Figure 3. Typical transfer characteristic
($T_J=25^\circ\text{C}$)

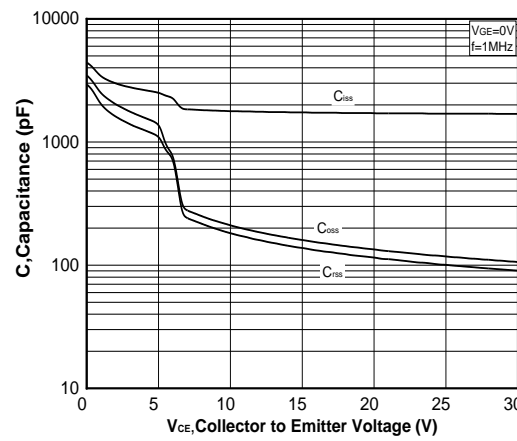


Figure 4. Capacitance characteristic
($V_{GE}=0\text{V}$, $f=1\text{MHz}$)

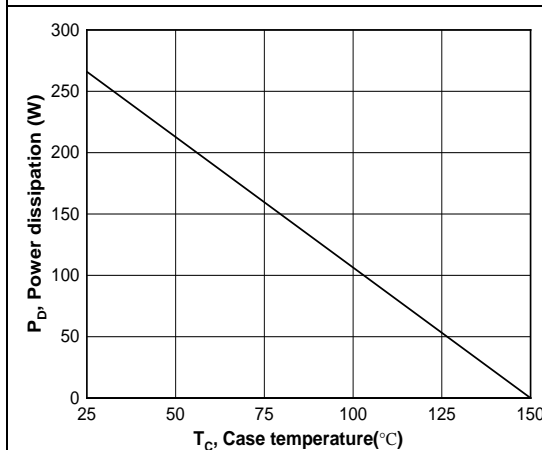


Figure 5. Power dissipation as a function of
case temperature ($T_J \leq 175^\circ\text{C}$)

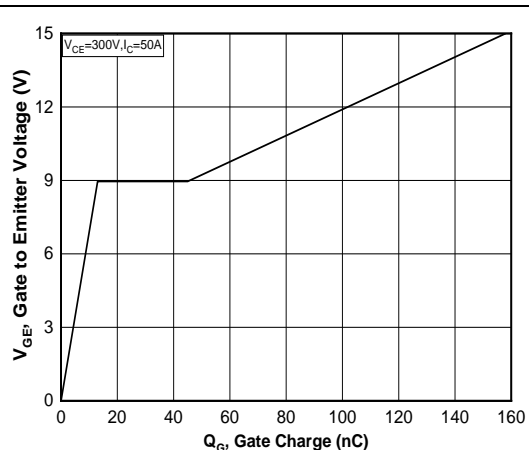
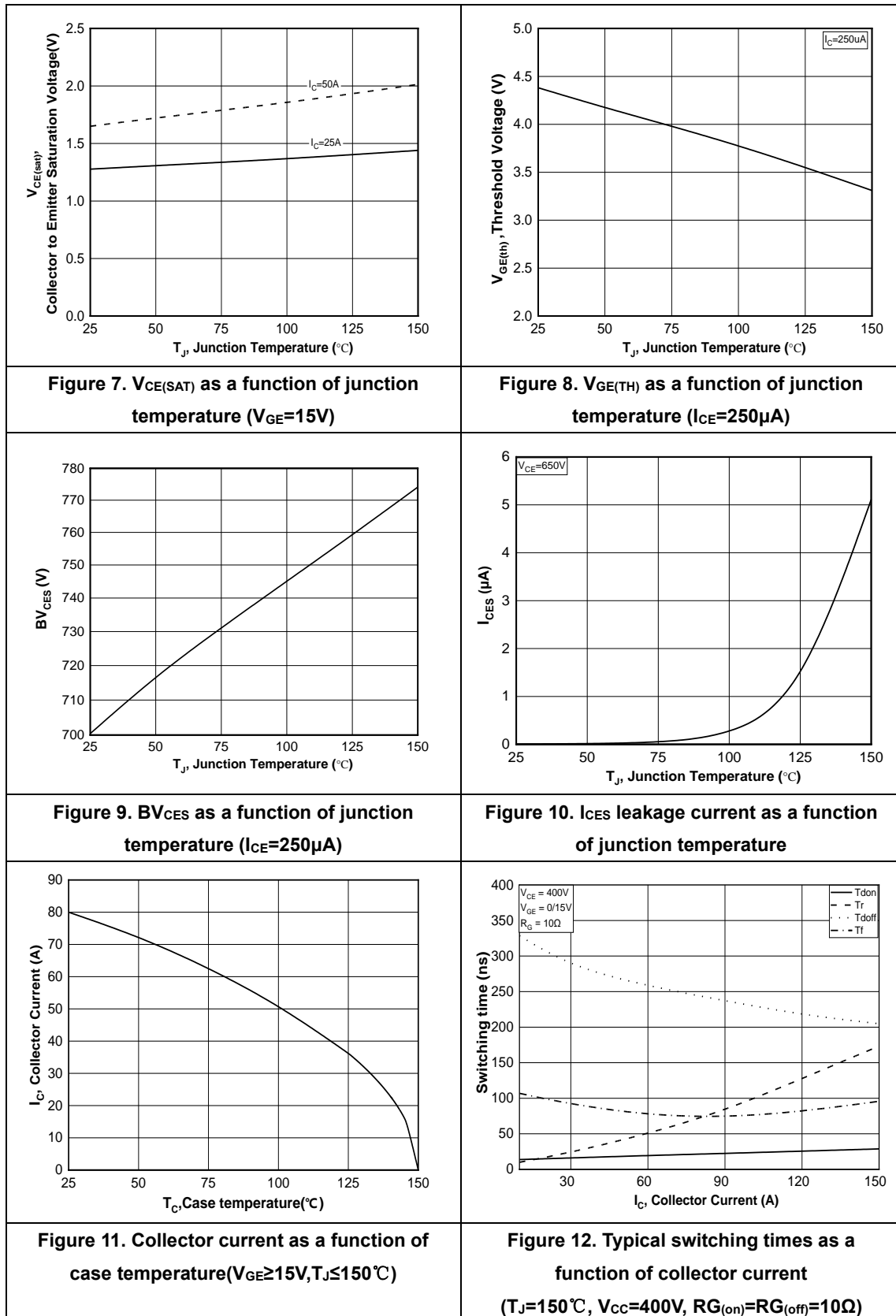


Figure 6. Typical gate charge ($I_C=50\text{A}$)



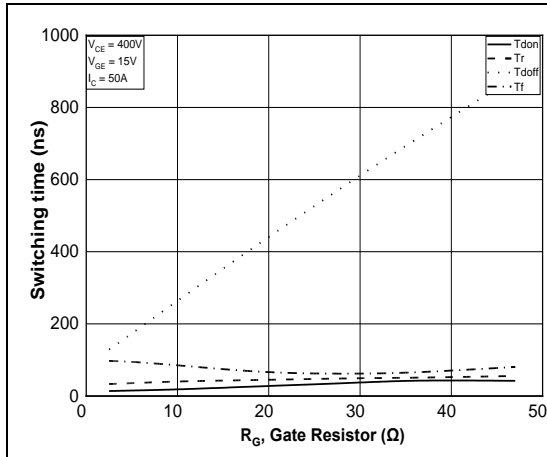


Figure 13. Typical switching times as a function of gate resistance
($T_J=150^{\circ}\text{C}$, $V_{CE}=400\text{V}$, $I_C=50\text{A}$)

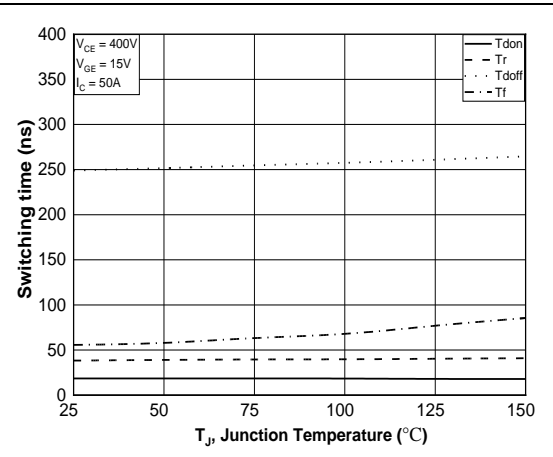


Figure 14. Typical switching times as a function of junction temperature
($V_{CE}=400\text{V}$, $I_C=50\text{A}$, $R_{G(on)}=R_{G(off)}=10\Omega$)

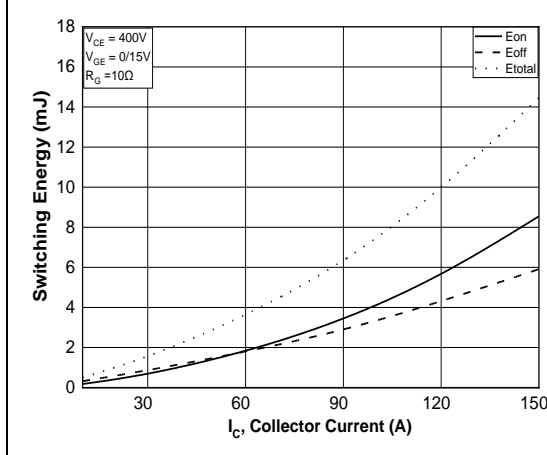


Figure 15. E_{on} , E_{off} as a function of I_C
($T_J=25^{\circ}\text{C}$)

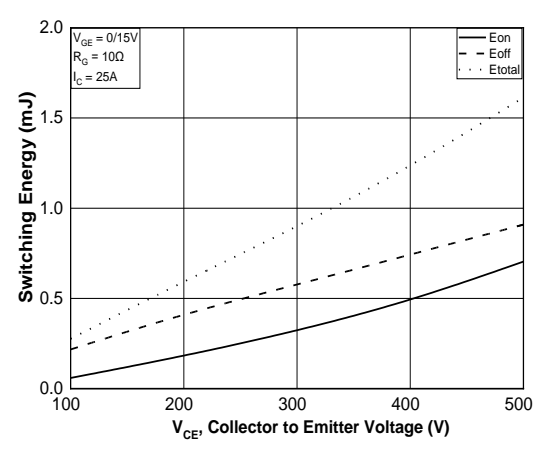


Figure 16. E_{on} , E_{off} as a function of V_{CE}
($T_J=25^{\circ}\text{C}$)

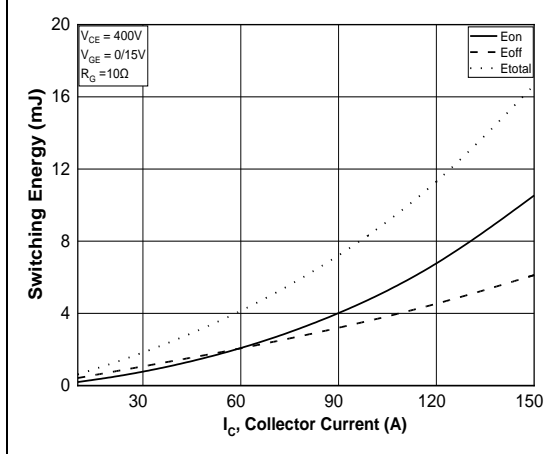


Figure 17. E_{on} , E_{off} as a function of I_C
($T_J=150^{\circ}\text{C}$)

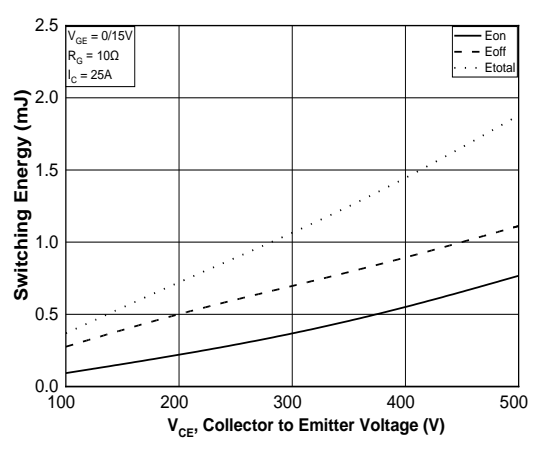


Figure 18. E_{on} , E_{off} as a function of V_{CE}
($T_J=150^{\circ}\text{C}$)

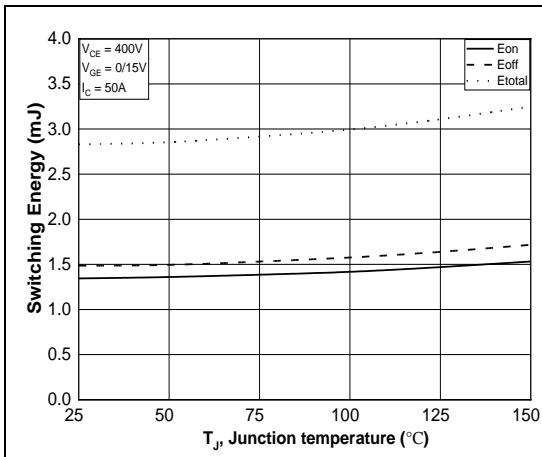


Figure 19. E_{on}, E_{off} as a function of junction temperature

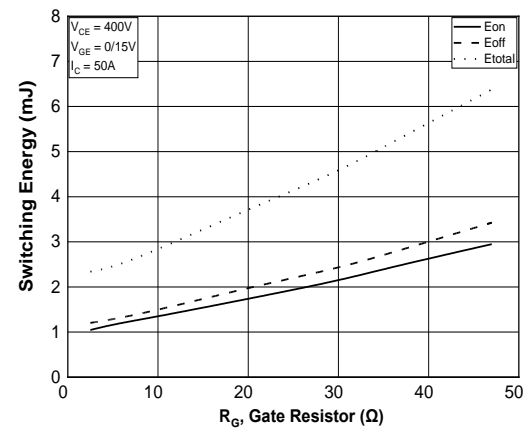


Figure 20. E_{on}, E_{off} as a function of gate resistance ($T_J=25\text{ }^{\circ}\text{C}$)

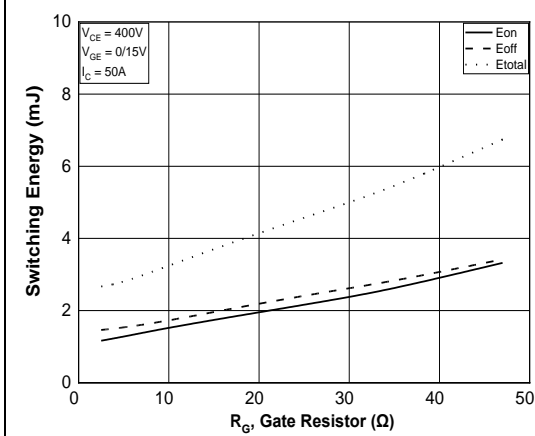


Figure 21. E_{on}, E_{off} as a function of gate resistance ($T_J=150\text{ }^{\circ}\text{C}$)

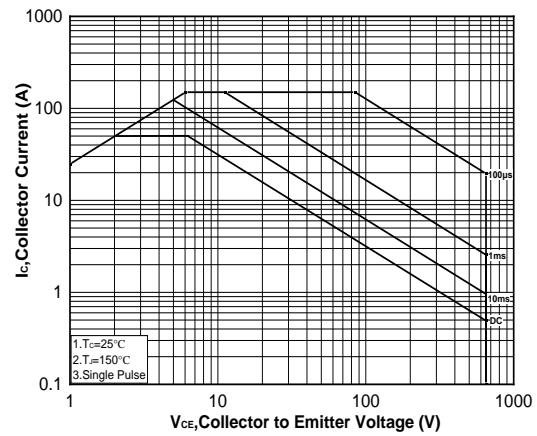
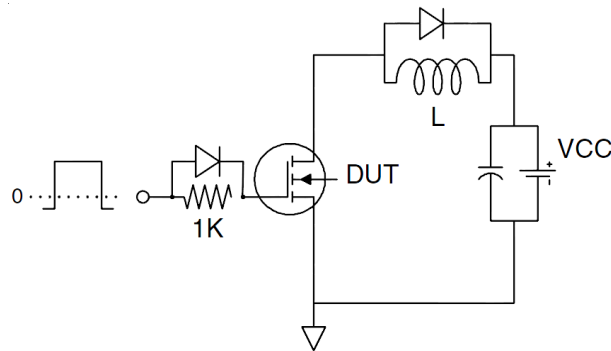


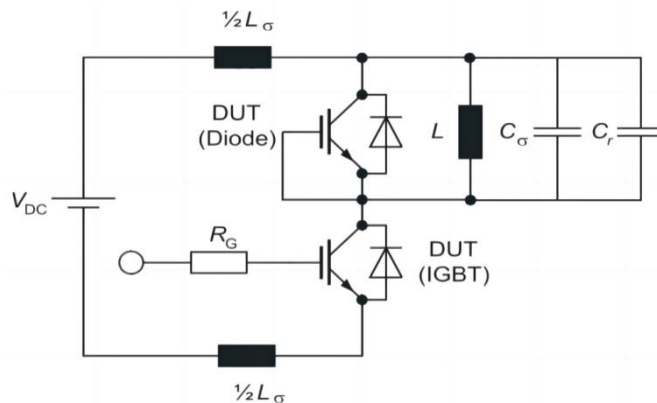
Figure 22. Forward bias safe operating area

➤ Test Circuit

(1) Gate Charge Test Circuit

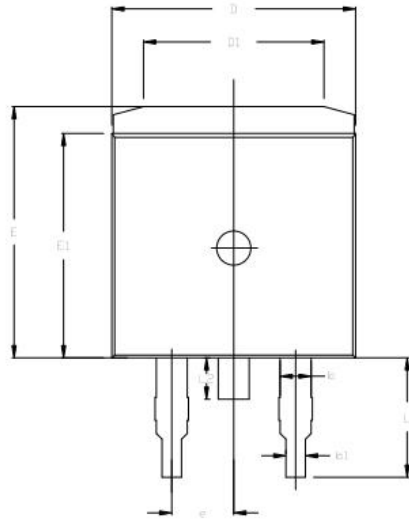


(2) Switch Time Test Circuit

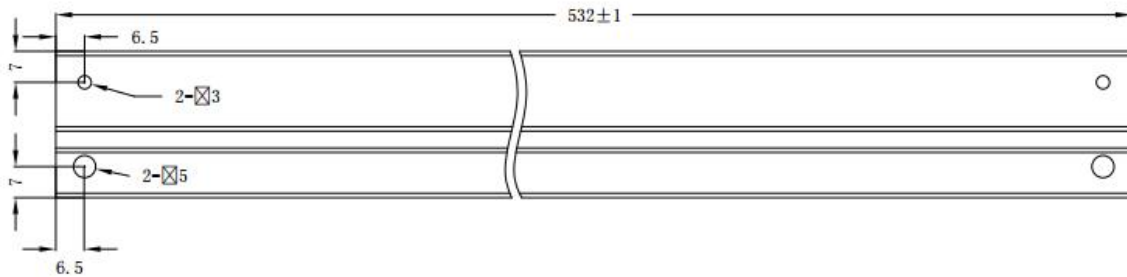




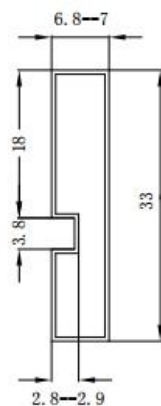
➤ Package Information



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	4.40	--	4.60
b	1.20	--	1.36
b1	0.70	--	0.90
C	0.48	--	0.53
C1	1.28	--	1.32
C2	0.04	0.12	0.20
D	9.80	10.00	10.20
D1	7.25	7.40	7.55
E	10.20	10.30	10.40
E1	9.10	9.20	9.30
e	--	2.54	--
L	4.70	4.90	5.10
L1	2.40	2.60	2.80
L2	1.50	1.70	1.90



T=0.5 ±0.1



技术要求:

1. 材料: 透明PVC
2. 表面电阻: $10E5 \sim 10E10$ OHMS/SQ
3. 未注尺寸公差 ± 0.3
4. 黑色钉子由厂家出货时塞于左端



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